

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Hiatt et al.

Serial No.: 10/705,409

Filed: November 10, 2003

For: SUBSTRATE SUPPORTS FOR USE
WITH PROGRAMMABLE MATERIAL
CONSOLIDATION APPARATUS AND
SYSTEMS

**VIA ELECTRONIC FILING
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Notice of Allowance Mailed:

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**FEE ADDRESSEE FOR RECEIPT OF PTO NOTICES
RELATING TO MAINTENANCE FEES**

Mail Stop ISSUE FEE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

1. This letter is to specify that the FEE ADDRESSEE for this patent is:

MICRON TECHNOLOGY, INC.

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2. The Customer Number for the Fee Addressee is 26809.
3. Any prior FEE ADDRESSEE for this patent is hereby revoked.
4. It is certified that the person whose signature appears below has the authority to change the FEE ADDRESSEE for this patent.

Respectfully submitted,



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